

On this page, the keywords and parameters are now in **bold**.
On page 2, they are in **Arial Black**
On page 3, they are **green**.
On page 4, they are **shaded**.

4 File Header Information

Keyword [IBIS Ver]

Required Yes

Description

Specifies the IBIS template version. This keyword informs electronic parsers of the kinds of data types that are present in the file.

Usage Rules

[**IBIS Ver**] must be the first keyword in any IBIS file. It is normally on the first line of the file, but can be preceded by comment lines that must begin with a "|".

```
[IBIS Ver] 5.0 | Used for template variations
```

Keyword [Comment Char]

Required No

Description

Defines a new comment character to replace the default "|" (pipe) character, if desired.

Usage Rules

The new comment character to be defined must be followed by the underscore character and the letters "char".

For example:

"|_char" redundantly redefines the comment character to be the pipe character. The new comment character is in effect only following the [**Comment Char**] keyword. The following characters MAY be used:

```
! " # $ % & ' ( ) * , : ; < > ? @ \ ^ ` { | } ~
```

Other Notes

The [**Comment Char**] keyword can be used anywhere in the file, as desired.

```
[Comment Char] |_char
```

Keyword [File Name]

Required Yes

Description

Specifies the name of the IBIS file.

Usage Rules

The file name must conform to the rules in paragraph 3 of Section 3, General Syntax Rules and Guidelines. In addition, the file name must use the extension ".ibs", ".pkg", or or ".ebd". .

[File Name] ver5_0.ibs

5 Component Description

Keyword [Component]

Required Yes

Description

Marks the beginning of the IBIS description of the integrated circuit named after the keyword.

Sub-Params

Si_location, Timing_location

Usage Rules

If the .ibs file contains data for more than one component, each section must begin with a new [Component] keyword. The length of the component name must not exceed 40 characters, and blank characters are allowed.

NOTE: Blank characters are not recommended due to usability issues.

Si_location and Timing_location are optional and specify where the Signal Integrity and Timing measurements are made for the component. Allowed values for either subparameter are 'Die' or 'Pin'. The default location is at the 'Pin'.

```
[Component]        7403398 MC452
|
Si_location        Pin        | Optional subparameters to give measurement
Timing_location   Die        | location positions
```

Keyword [Manufacturer]

Required Yes

Description

Specifies the name of the component's manufacturer.

Usage Rules

The length of the manufacturer's name must not exceed 40 characters (blank characters are allowed, e.g., Texas Instruments). In addition, each manufacturer must use a consistent name in all .ibs files.

```
[Manufacturer]    Intel Corp.
```

Keyword [Package]

Required Yes

Description

Defines a range of values for the default packaging resistance, inductance, and capacitance of the component pins.

Sub-Params

R_pkg, L_pkg, C_pkg

Usage Rules

The typical (typ) column must be specified. If data for the other columns are not available, they must be noted with "NA".

Other Notes

If RLC parameters are available for individual pins, they can be listed in columns 4-6 under keyword [Pin]. The values listed in the [Pin] description section override the default values defined here. Use the [Package Model] keyword for more complex package descriptions. If defined, the [Package Model] data overrides the values in the [Package] keyword. Regardless, the data listed under the [Package] keyword must still contain valid data.

[Package]				
variable	typ	min		max
R_pkg	250.0m	225.0m		275.0m
L_pkg	15.0nH	12.0nH		18.0nH
C_pkg	18.0pF	15.0pF		20.0pF

Keyword [Pin]

Required Yes

Description

Associates the component's I/O models to its various external pin names and signal names.

6 Model Statement

Keyword [Model]

Required Yes

Description

Used to define a model, and its attributes.

Sub-Params

Model_type, Polarity, Enable, Vinl, Vinh, C_comp, C_comp_pullup, C_comp_pulldown, C_comp_power_clamp, C_comp_gnd_clamp, Vmeas, Cref, Rref, Vref

Usage Rules

Each model type must begin with the keyword [Model]. The model name must match the one that is listed under a [Pin], [Model Selector] or [Series Pin Mapping] keyword and must not contain more than 40 characters. A .ibs file must contain enough [Model] keywords to cover all of the model names specified under the [Pin], [Model Selector] and [Series Pin Mapping] keywords, except for those model names that use reserved words (POWER, GND and NC).

Model_type must be one of the following:

Input, Output, I/O, 3-state, Open_drain, I/O_open_drain, Open_sink, I/O_open_sink, Open_source, I/O_open_source, Input_ECL, Output_ECL, I/O_ECL, 3-state_ECL, Terminator, Series, and Series_switch.

For true differential models documented under Section 6b, **Model_type** must be one of the following:

Input_diff, **Output_diff**, **I/O_diff**, and **3-state_diff**

Keyword [Model Spec]

Required No

Sub-Params

Vinh, Vinl, Vinh+, Vinh-, Vinl+, Vinl-, S_overshoot_high, S_overshoot_low, D_overshoot_high, D_overshoot_low, D_overshoot_time, D_overshoot_area_h, D_overshoot_area_l, D_overshoot_ampl_h, D_overshoot_ampl_l, Pulse_high, Pulse_low, Pulse_time, Vmeas, Vref, Cref, Rref, Cref_rising, C_ref_falling, Rref_rising, Rref_falling, Vref_rising, Vref_falling, Vmeas_rising, Vmeas_falling, Rref_diff, Cref_diff

Description

The [Model Spec] keyword defines four columns under which specification subparameters are defined.

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